November 2014

FFPF30UA60S

30 A, 600 V, Ultrafast II Diode

Features

- Ultrafast Recovery, t_{rr} = 90 ns (@I_F = 30 A)
- Max Forward Voltage, V_F = 2.2 V (@ T_C = 25°C)
- 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- RoHS Compliant

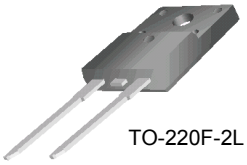
Applications

- Boost Diode in PFC and SMPS
- Welder, UPS and Motor Control Application

Description

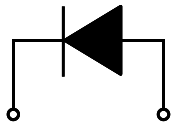
The FFPF30UA60S is a ultrafast II diode with low forward voltage drop. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial application.

Pin Assignments



TO-220F-2L

1. Cathode 2. Anode



1. Cathode 2. Anode

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Rating	Unit
V_{RRM}	Peak Repetitive Reverse Voltage	600	V
V_{RWM}	Working Peak Reverse Voltage	600	V
V_R	DC Blocking Voltage	600	V
$I_{F(AV)}$	Average Rectified Forward Current @ T_C = 43°C	30	A
I_{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	180	A
T_J, T_{STG}	Operating and Storage Temperature Range	-65 to +175	°C

Thermal Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Max.	Unit
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	2.5	°C/W

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FFPF30UA60S	FFPF30UA60S	TO-220F-2L	Tube	N/A	N/A	50

Electrical Characteristics $T_C = 25^oC$ unless otherwise noted

Symbol	Parameter		Min.	Typ.	Max.	Unit
V_F1	I_F = 30 A I_F = 30 A	$T_C = 25^oC$ $T_C = 125^oC$	- -	- -	2.2 2.0	V
I_R1	V_R = 600 V V_R = 600 V	$T_C = 25^oC$ $T_C = 125^oC$	- -	- -	100 150	μA
t_{rr} I_{rr} Q_{rr}	I_F = 30 A, di_F/dt = 200 A/μs	$T_C = 25^oC$	- - -	- - -	90 8 360	ns A nC
W_{AVL}	Avalanche Energy (L = 40 mH)		20	-	-	mJ

Notes:
1: Pulse: Test Pulse width = 300μs, Duty Cycle = 2%

Test Circuit and Waveforms

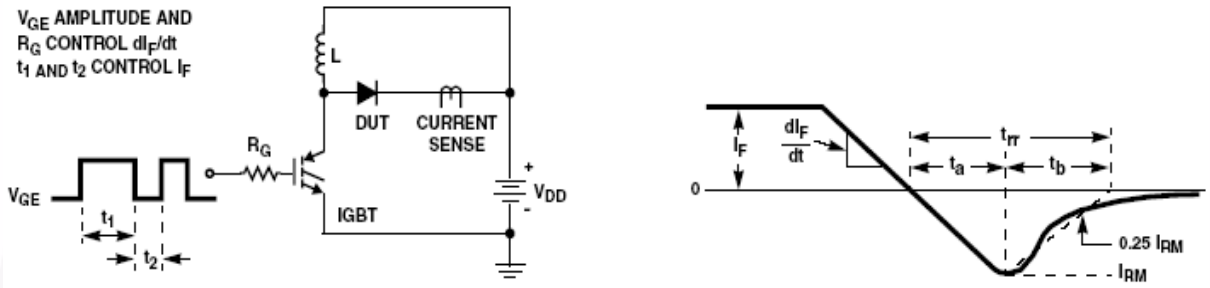


Figure 1. Diode Reverse Recovery Test Circuit & Waveform

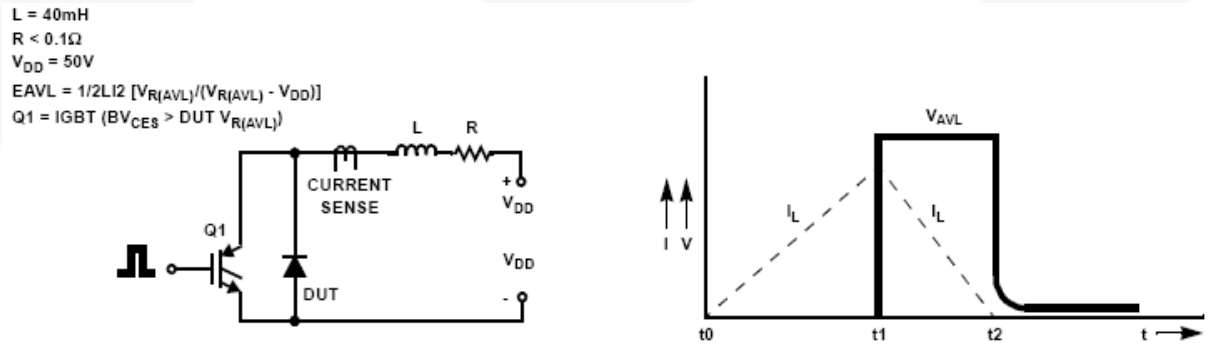


Figure 2. Unclamped Inductive Switching Test Circuit & Waveform

Typical Performance Characteristics

Figure 3. Typical Forward Voltage Drop vs. Forward Current

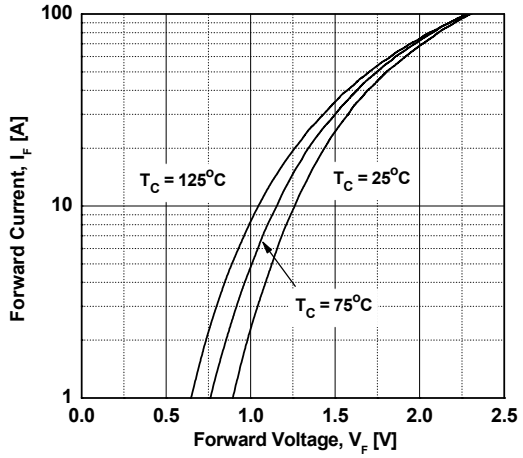


Figure 4. Typical Reverse Current vs. Reverse Voltage

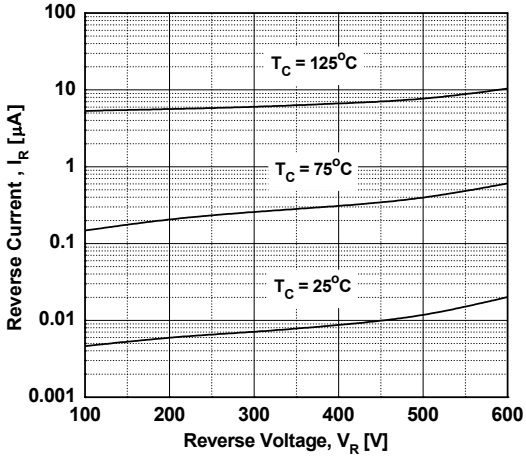


Figure 5.Typical Junction Capacitance

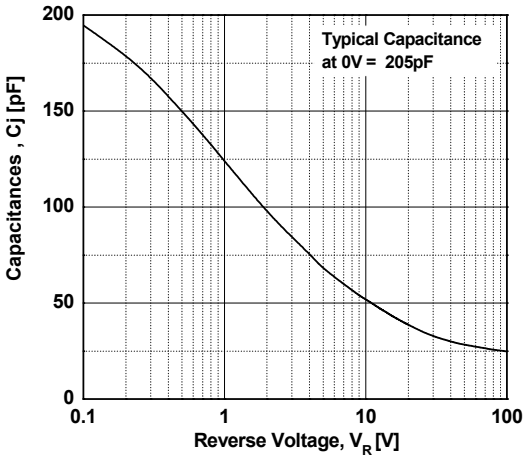


Figure 6. Typical Reverse Recovery Time vs. di_F/dt

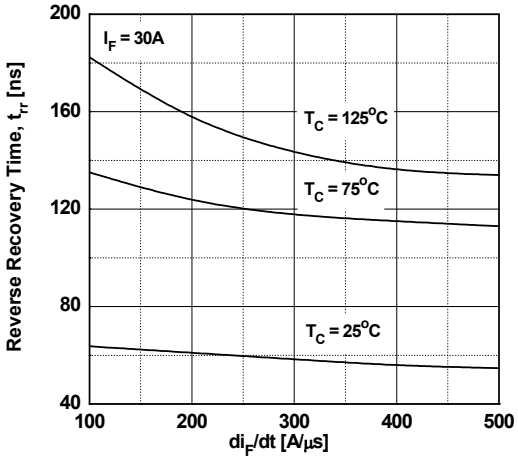


Figure 7. Typical Reverse Recovery Current vs. di_F/dt

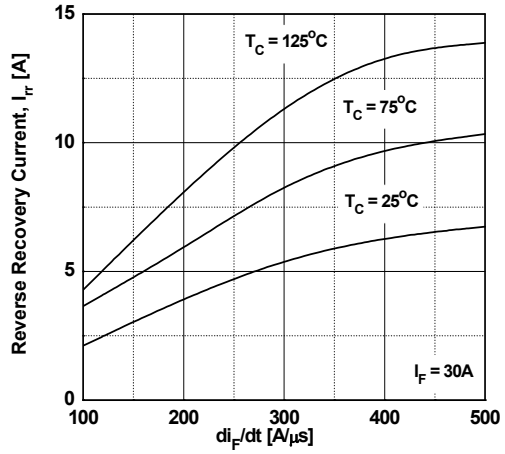
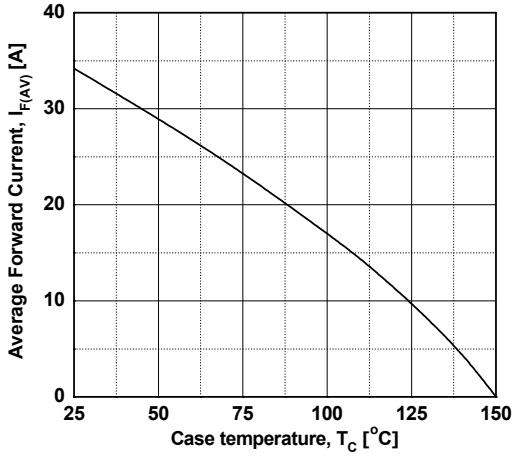


Figure 8. Forward Current Derating Curve



Mechanical Dimensions

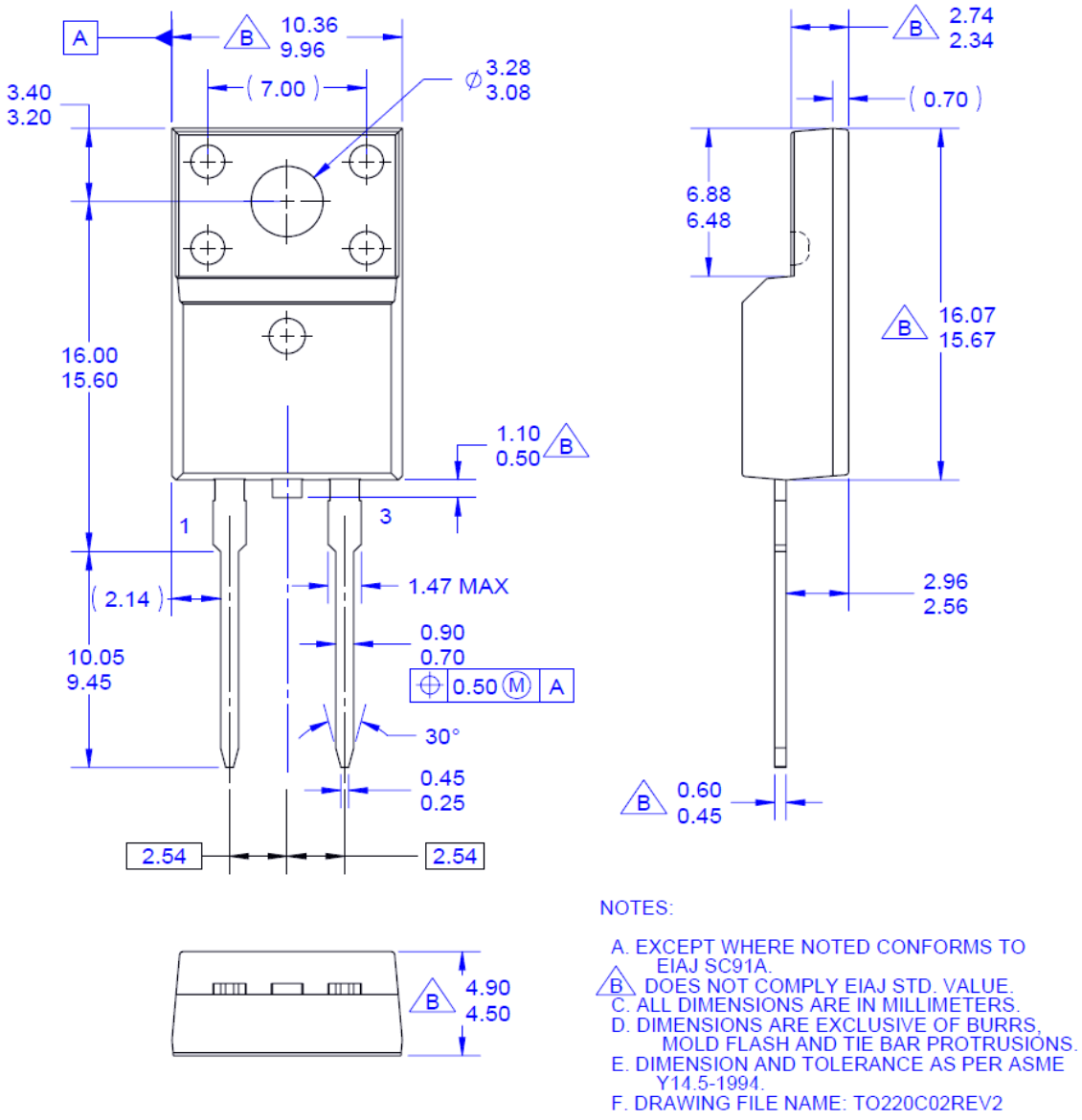


Figure 9. TO-220F 2L - 2LD; TO220; MOLDED; FULL PACK

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